## DC-DC Converters Layout (180nm)

<u>Customer</u>: The customer is a tier-1 company.

**Project**: The DC-DC was designed in state of art 180nm process.

Mirafra's Responsibility: Mirafra was involved in completion of full ASIC level layout.

- Floorplan of complete core blocks like Chargepump, Drivers, LDO delivery.
- Contribution to all core blocks layout design and top level routing.
- Maintaining robust signal widths for the entire signal path.
- Context dependency layout to take care of coupling, matching, EMIR etc.
- Maintaining required RV vias from the Powerfets to Bump.

**Challenges:** Managing high current the current consumption of 2A

**Tools used**: Virtuoso (Cadence), Assura-PVS

**Engagement Model**: Delivered project in period of 3 months with team of 5 people.